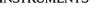


# ISO5852SDW Driving and Protecting SiC and IGBT Power Modules

This user's guide describes the characteristics, operation, and use of the ISO5852SDWEVM-017 Evaluation Module (EVM). This TI EVM provides driving and protection for popular Silicon Carbide (SiC) MOSFET and Si IGBT Power Modulues. A complete schematic diagram, printed-circuit board layouts, and bill of materials are included in this document.

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## 1 Overview

The ISO5852SDWEVM-017 is a compact, dual channel isolated gate driver board providing drive, bias voltages, protection and diagnostic needed for half-bridge SiC MOSFET and Si IGBT Power Modules housed in 150-mm × 62-mm × 17-mm packages.

This TI EVM is based on 5.7-kVrms reinforced isolation driver IC ISO5852SDW in SOIC-16DW package with 8.0 mm creepage and clearance. The EVM includes SN6505B based isolated DC-DC transformer bias supplies.

Isolated temperature and input rail monitoring is provided by 5-kVrms isolated amplifiers AMC1301.

Compact form factor 100-mm × 62-mm × 6.6-mm, excluding connector height, allows direct connection to standard 62-mm half-bridge modules.

#### 1.1 Features

This EVM supports the following features:

- 20-A peak split sink and source drive current to optimize turn on and turn off switching time
- Two, 2-W output bias supplies with undervoltage lockout (UVLO) and overvoltage lockout (OVLO) protection
- Turn ON and turn OFF drive voltages can be programmed independently from 12 V to 21 V and from -3.3 V to -7 V respectively by using two input supplies from 3.3 V to 5.3 V
- Robust noise-immune solution with CMTI >100 V/ns
- Supports 5-kVrms Reinforced Isolation for input rail up to 1700-V
- · Programmable Short-circuit sensing and Soft Turn-OFF protection by de-saturation circuit
- 2-A Active Miller Clamp
- Output Short Circuit Clamp
- · Fault feedback with reset
- · Temperature and input rail monitoring

## 1.2 Applications

This EVM is used in the following applications:

- Solar inverters
- Motor drives
- HEV and EV chargers
- Wind turbines
- Transportation
- UPS



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# 1.3 Description

Compact driver board ISO5852SDWEVM-017 supports SiC power modules by reducing parasitics, minimizing switching loss and EMI and providing full required protection and diagnostics features.

# 1.3.1 Specification

Electrical parameters of the board are shown in Table 1.

**Table 1. Electrical Specifications** 

	PARAMETER	TEST CONDITION	MIN	NOM	MAX	UNIT
SUPPLY VOLT	TAGES AND CURRENTS				<del> </del>	
VCC	Primary supply voltage		4.5	5.0	5.5	V
IVCCQ	Primary quiescent current	IN+, IN- low		30		mA
IVCCS	Primary supply current	FSW = 10kHz, CLOAD = 10nF		210		mA
VCCUR	Vcc rising UVLO threshold			4.5	4.6	V
VCCUF	Vcc falling UVLO threshold		4.2	4.3		V
VCCUH	Vcc UVLO hysteresis			0.2		V
VCCOR	Vcc rising OVLO threshold			5.7	5.8	V
VCCOF	Vcc falling OVLO threshold		5.4	5.5		V
VCCOH	Vcc UVLO hysteresis			0.2		V
VCC2U, VCC2L	Turn ON drive voltages	Transformer 750342879	15	17	19	V
VCC2U, VCC2L	Turn OFF drive voltages	Transformer 750313734	-5.9	<b>-</b> 5	-4.7	V
DRIVE CURRE	NT AND POWER				\ldots	
IOH	Peak source current	CLOAD = 10nF	15	20		Α
IOL	Peak sink current	CLOAD = 10nF	15	20		Α
PDRV	Drive power per channel	At 25°C			2.0	W
INPUT/OUTPU	T SIGNALS				\ldots	
VINR, VRSTR	INL+, INU+, RST rising threshold				0.7 x VCC	V
VINF, VRSTF	INL+, INU+, RST falling threshold		0.3 × VCC			V
VINH, VRSTH	INL+, INU+, RST hysteresis			0.15 × VCC		V
VFLU, VFLL	FL, FU Fault voltage	IFLT = 5 mA			0.2	V
VFLU, VFLL	FL, FU Fault current	Internal pullup current		100		μΑ
VFLTH	F high level	At VCC = 4.5 V	4.4	4.5		V
VFLTL	F low level	At VCC = 4.5 V			0.1	V
ATEMP	Thermistor monitor gain			8.2		
ARAIL	Input rail monitor gain			8.2		
TIMING PARA	METERS				\ldots	
TRISE	Drive output rise time	CLOAD = 10nF		30		ns
TFALL	Drive output fall time	CLOAD = 10nF		34		ns
TPROP	Propagation delay	CLOAD = 100nF		130	150	ns
TSKEW	Pulse skew				20	ns
TGLITCH	Input glitch filter		20	30	40	ns
TUVLO	UVLO recovery delay			50		μs
TOVOL	OVLO recovery delay			50		μs



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# **Table 1. Electrical Specifications (continued)**

	PARAMETER	TEST CONDITION	MIN	NOM	MAX	UNIT
SHORT CIRCU	JIT PROTECTION				-	
VDESAT	Nominal desaturation threshold	Can be programmed by resistors down to 4 V	8.3	9.0	9.5	V
TDESATBLN K	Blanking time		310	400	480	ns
TDS90	Response time to 90% VOUTHL	CLOAD = 10nF		553	760	ns
TDS10	Response time to 10% VOUTHL	CLOAD = 10nF		2	3.5	μs
ICHARGE	Capacitor charge current		0.42	0.5	0.58	mA
IDISCHARGE	Capacitor discharge current		9	14		mA
VCLAMP	Miller clamp threshold		1.6	2.1	2.5	V
ICLAMP	Miller clamp current			4		Α
ISOLATION						
CMTI		CMTI	100			V/ns
VISO	Withstand isolation voltage	Reinforced, 60s	5.0			kVrms
CI	Barrier capacitance				20	pF
TA	Operating Ambient Temperature		-40	25	125	оС
SIZE					1	
Board size		Without connector	100 x 62 x 6.6			mm



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# 1.3.2 Block Diagram

The ISO5852SDWEVM-017 board block diagram is shown in Figure 1.

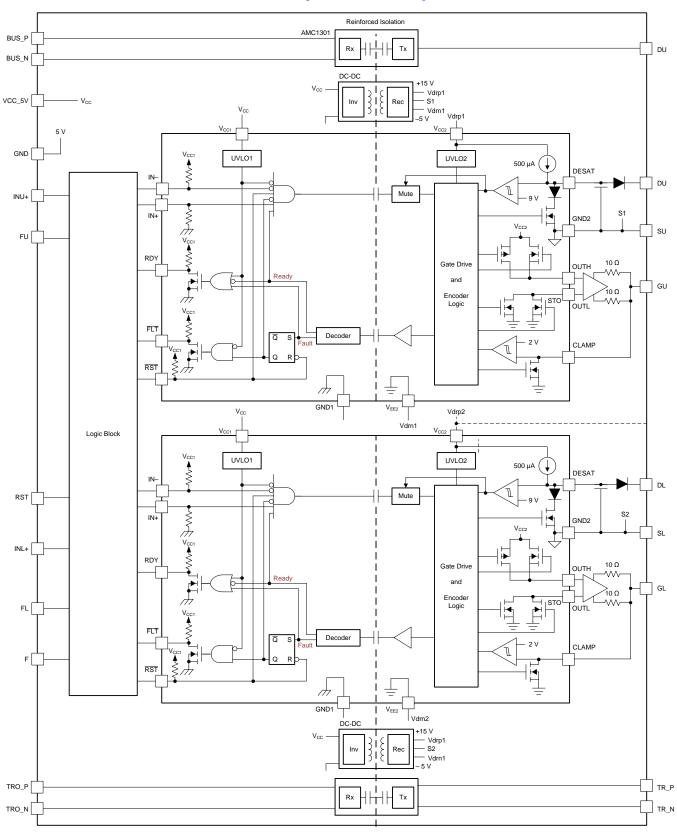


Figure 1. ISO5852SDWEVM-017 EVM Block Diagram



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It includes two isolated channels with the following key functional blocks:

- 20A source/sink 5.7 kVrms Isolated driver using ISO5852SDW driver IC
- Split rail bias supply using two 424 kHz transformer drivers SN6505B to generate separately +17 V rail for turn ON and -5 V rail for turn OFF
- Input logic block with shoot-through prevention
- Output protection and diagnostic block
- Analog amplifiers AMC1301 to monitor temperature inside the module and input voltage rail with 5.0 kVrms isolation

#### 1.3.3 Isolated Gate Driver ISO5852S

ISO5852SDW, isolated driver in SOIC-16DW package with 8.0mm creepage and clearance providing 5.7kVrms reinforced isolation, includes all main short circuit protection features. ISO5852SDW driver IC employs TI proprietary high voltage, low propagation delay, CMTI immune capacitive isolation technology. The list of isolation safety certifications from agencies like VDE, CSA, UL and CQC is provided in related datasheet. Short, 76 ns propagation delay with only 20 ns skew allows accurate control of power devices. Figure 1 includes block diagram of ISO5852SDW driver.

Primary side voltage Vcc1 is controlled by internal UVLO1 circuit with 2.25Vmax rising threshold and 1.7Vmin falling threshold. Inverting and non-inverting input signals IN- and IN+ have CMOS thresholds derived from Vcc1 voltage: 0.7 x Vcc1 max rising and 0.3 x Vcc1 min falling accordingly. Secondary side voltage Vcc2 can go up to 35V abs. max. Turn ON drive voltage between Vcc2 and GND2 pins is controlled by internal UVLO2 circuit with 13Vmax rising threshold and 9.5V min falling threshold. The split sink/source output allows setting optimal turn ON and turn OFF time by selecting separate gate resistors between driver output and gate of power device. This driver has all necessary short circuit protection features including desaturation current sensing, soft short circuit turn OFF, Miller gate clamp, fault, power ready and reset signals.

## 1.3.4 Split-Rail Bias Supply using SN6505B

Split rail bias supply generates 17V turn ON, and -5V turn OFF voltages using two push-pull transformer drivers SN6505B operating at 424kHz and housed in 6-pin small SOT-23 package.

The SN6505B is supplied through Vcc terminal from external source in the range from 2.25 to 5.5V. Input voltage is controlled by UVLO circuit having rising threshold 2.25Vmax and falling threshold 1.7V min. Internal oscillator operates at 424kHz typical frequency within range from 363 kHz min. to 517 kHz max.. The SN6505 employs spread spectrum clocking technique to minimize EMI. The output stage includes 1A push-pull switches rated up to 16 V abs. max. The switches are protected by current limit circuit tripped at 1.7 A typ. level. The device also protected by thermal shutdown circuit triggered at 168 °C typical threshold and returning back to normal operation at 150 °C typical. Additional features include soft start and Enable signal. Because there is no closed feedback loop in this inexpensive bias supply solution, it operates like DC-DC transformer and requires low tolerance primary voltage to maintain output voltages within ±10% range.

## 1.3.5 Input Logic

Input logic block fulfills the following functions:

- Provides additional UVLO and OVLO protection of secondary side drive voltages using sensing on primary side Vcc based on window comparator TPS3700
- Generates separate fault signals for each channel when the short circuit occurs along with general system fault signal using AND logic CMOS IC SN74AHC1G08QDBVRQ1
- Generates combined Reset signal output for both isolated channels
- Provides isolated differential output signals from temperature and input rail monitoring circuits using isolated amplifiers AMC1301
- Can be set for driver outputs overlapping prevention mode by having shunt resistors R48 and R52 in place. To allow outputs overlapping simply remove shunt resistors R48 and R52.



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## 1.3.6 Output Protection and Diagnostic

The output boost and protection blocks fulfill the following functions:

- Boost sink and source currents up to 20 A typical
- · Determine short circuit conditions using Vds sensing
- Provide analog isolated input rail sensing signal using AMC1301 amplifier
- Provide analog isolated temperature monitoring using thermistor inside the module and AMC1301 amplifier

## 1.3.7 Isolated Differential Amplifier AMC1301

The AMC1301 is a precision, isolated amplifier with an output separated from the input circuitry by an isolation barrier providing protection from electromagnetic and electrical noise in the system.

The input of the AMC1301 device is optimized for sensing signals in ±250 mV range with high immunity to common mode noise. The amplifier is housed in wide body SOIC-8DWV package with 9 mm creepage and clearance.

#### 1.3.8 Board Views

Top view of the driver board ISO5852SDWEVM-017 is shown in Figure 2. Figure 3 shows the driver EVM soldered on top of power module.

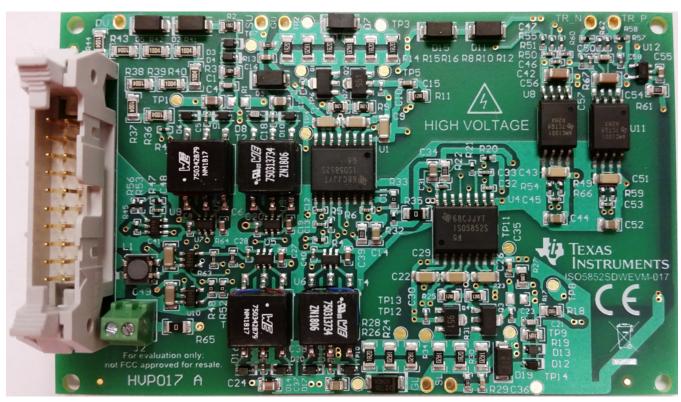


Figure 2. ISO5852SDWEVM-017 Top View



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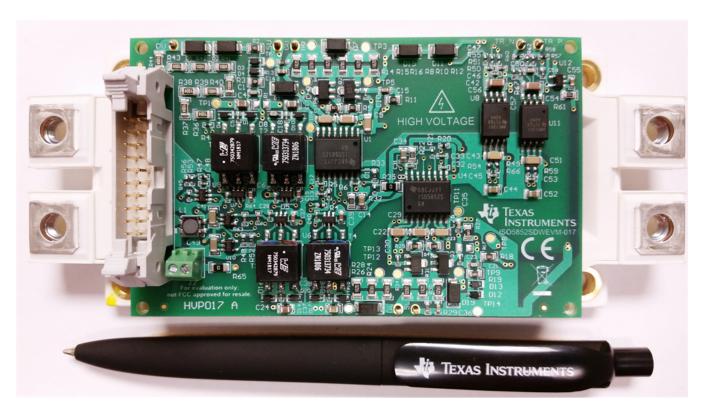


Figure 3. ISO5852SDWEVM-017 Mounted on Top of Power Module

# 2 Test Setup and Results

Test setup and related waveforms presented in User's Guide are for ISO5852SDWEVM-017 EVM EXCLUDING any user provided power modules attached to backside of the EVM. Capacitive load presented by power module is emulated by 10 nF capacitors C16 and C36. When EVM is attached to and evaluated with power module, capacitors C16 and C36 should be removed.

## 2.1 Before You Begin

When starting to evaluate and test the ISO5852SDWEVM-017 EVM, it will typically be in a stand-alone configuration, separate from power module. This EVM does not internally generate high voltages or high temperatures.

In the start-up configuration, there will be no high voltage or high temperature capable of presenting the user with an electrical shock hazard or burn resulting from elevated temperature risks provided the EVM is used within its electrical load rating limits established in Table 1.

# **WARNING**

To minimize risk of electric shock hazard always follow safety practices normally followed in a development laboratory. Refer to TI's EVM High Voltage guideline accompanying this EVM.

However, to evaluate isolated input rail amplifier voltages in accordance with the described below test procedure 2.2.4, which requires the addition of an external power source with maximum rating of 300 VDC, high voltage may be accessible between board test points DU and SL.



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To minimize risk of electrical shock hazard, always follow all high voltage safety rules and regulations while operating electrical equipment!

When evaluating ISO5852SDWEVM-017 with EVM attached to its intended vendor provided power module as part of the system level measurements and assessments, the power module will have accessibility of high voltage and high temperatures that impact the EVM's operating conditions as well. High voltages with transients up to 1500Vpk can appear between isolated areas of the EVM, bounded as illustrated in Figure 9. The externally provided power module also radiates heat that indirectly provides air flow and convection that can elevate the temperature of EVM board.

# **WARNING**

To minimize risk of fire hazard, it is critical to assure that the external power module's electrical and thermal ratings are never exceeded as published by the external power module's manufacturer's datasheet, and the maximum temperature of any external power module should never exceed 130 °C.

The EVM provides isolated thermal dissipation diagnostic signals available at connector J1 shown in Figure 9, which measure high voltage input rail and thermistor temperatures inside the external power module. Both BUS\_P (pin 17) to BUS\_N (pin 18) and TRO\_P (pin 20) to TRO\_N (pin 19) diagnostic signals must be strictly monitored to assure both high voltage and thermal protective features are being utilized.

The user is required to provide necessary interface controller hardware to shut down and deenergize the system immediately if BUS\_P to BUS\_N signal exceeds 1.85 VDC, or signal TRO\_P to TRO\_N drops below 0.135 VDC.

## 2.2 Equipment

- Power Supplies
  - At least up to 6-V and 1-A power supply for powering EVM, for example: BK Precision, series 1715
  - At least up to 300-V and 10-mA power source for testing bus isolated sense amplifier within EVM
- Function Generator and accessories
  - One 2-channel function generator, for example: Tektronix AFG3102
  - Two standard 50-Ω BNC coaxial cables
  - Two 50-Ω BNC male to female feed-thru terminators, for example: Tektronix 011-0049-02
- Oscilloscope and accessories
  - Oscilloscope 500-MHz or higher with at least 4 channels, for example: Tektronix DPO7104
  - Four at least 500-MHz bandwidth passive voltage probes, for example: P6139A
- Six Digital Multi-Meters (DMM), for example Fluke 187
- Other
  - 20-wire flat cable with receptacle 71600-120LF from FCI with opposite end wired to PCB with related test points
  - Wires 7 to 10 inch long with clips on both ends to make jumpers on some test points
  - Resistance decade box, for example 72-7270 from Tenma

Test procedure includes four main tests with different test setups

- 1. Power up and bias supply voltages test
- 2. Input and output pulse switching waveforms test
- 3. Thermistor isolated amplifier input and output signal test
- 4. Bus voltage sense isolated amplifier input and output signal test



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All test setups shown in the following figures assume the flat test cable with receptacle and test points is attached to the connector J1 of the EVM.

#### 2.2.1 Power UP Test

Test setup for power up test is shown in Figure 4. For these tests digital multi-metersfor DC voltage measurements are set auto-range. MM1 is set for DC current measurements with expected range up to 500 mA. Here and in all test setups below, red arrows indicate positive terminals and black arrows indicate return terminal.

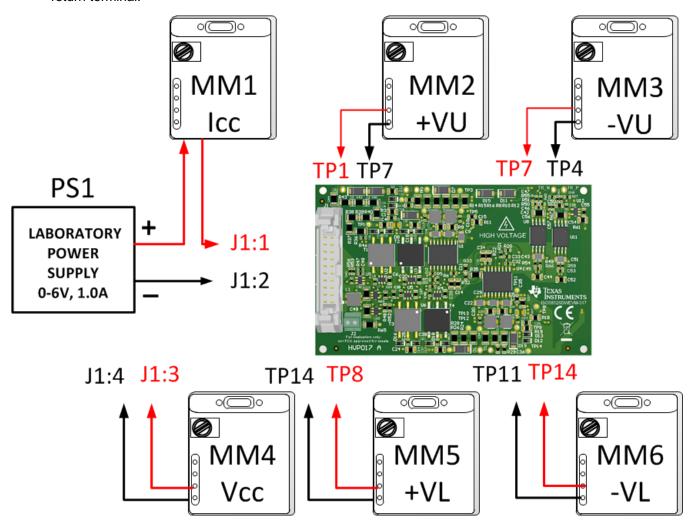


Figure 4. Power Up and Bias Supply Voltages VU and VL Test Setup

## WARNING

Before start testing make sure to follow all electrical safety and ESD protection requirements implemented at your company!

- 1. Enable power supply PS1
- 2. Gradually increase the voltage at PS1 and monitor voltage using MM4 and current using MM1
- 3. Verify measured voltage and current in accordance to Table 2. If current or voltage is outside the specified range, stop increasing the voltage at PS1 and return to initial stage
- 4. Gradually reduce the voltage at PS1 to 0 V and disable it



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Measured voltages and current should be within range shown in Table 2.

**Table 2. Voltages and Current During Power Up Test** 

MM4 (Vcc)	MM1 (Icc)	MM2 (+VU)	MM3 (-VU)	MM5 (+VL)	MM6 (-VL)
2.95 V – 3.05 V	< 30 mA	< ±0.1 V	< ±0.1 V	< ±0.1 V	< ±0.1 V
4.65 V – 4.75 V	130 mA – 145 mA	15.5 V – 16.5 V	4.5 V – 5.2 V	15.4 V – 16.4 V	4.5 V – 5.2 V
4.95 V – 5.05 V	135 mA – 150 mA	16.8 V – 17.5 V	5.0 V – 5.5 V	16.6 V – 17.4 V	5.0 V – 5.5 V
5.4 V – 5.45 V	140 mA – 155 mA	17.5 V – 19.0 V	5.5 V – 6.2 V	17.3 V – 18.8 V	5.5 V – 6.2 V
5.7 V < MM4 < 6 V	< 30 mA	< ±0.1 V	< ±0.1 V	< ±0.1 V	< ±0.1 V

# 2.2.2 Input and Output Switching Waveforms Test

Test setup for switching waveforms is shown in Figure 5.

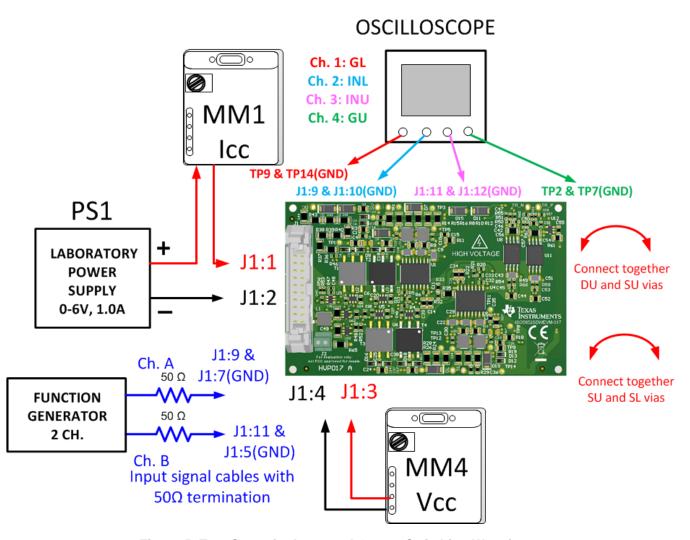


Figure 5. Test Setup for Input and Output Switching Waveforms



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Function generator settings are shown in Table 3.

## **Table 3. Function Generator Settings**

C	CHANNEL	MODE	FREQ.	WIDTH	DELAY	AMPL.	OFFSET	LOAD IMPED.	FREQUENC Y SET
	A (Ch.1)	Pulse	10 kHz	80 µs	0	4 Vpp	2.0 V	50 Ω	
	B (Ch.2)	Pulse	10 kHz	80 µs	50 µs	4 Vpp	2.0 V	50 Ω	Ch1 = Ch2, ON

Oscilloscope settings are shown in Table 4.

## **Table 4. Oscilloscope Settings**

CHANNEL	VERTICAL SCALE	HORIZONTAL SCALE	BANDWIDTH	COUPLING	TERMINATIO N	SYNC TRIGGER	RESOLUTION
Ch. 1(red)	10 V/div						
Ch. 2(blue)	3 V/div	50 µs/div	500 MHz or	DC	1 ΜΩ	Ch. 2	High
Ch. 3(pink)	3 V/div	30 με/αίν	above	DC	1 10122		riigii
Ch. 4(green)	10 V/div						

- 1. Enable power supply PS1
- 2. Gradually increase the voltage at PS1 into 4.95 V to 5.05 V range and monitor current using MM1 that should not exceed 150 mA
- 3. Enable channel A (ch.1) and channel B (ch.2) of function generator
- 4. Monitor current increase at MM1 but does not exceed 250 mA
- 5. Compare waveforms with typical screen shot showed in Figure 6
- 6. Disable function generator channels
- 7. Gradually reduce voltage at PS1 down to 0 and disable it (Make sure function generator outputs are disabled before this action!)



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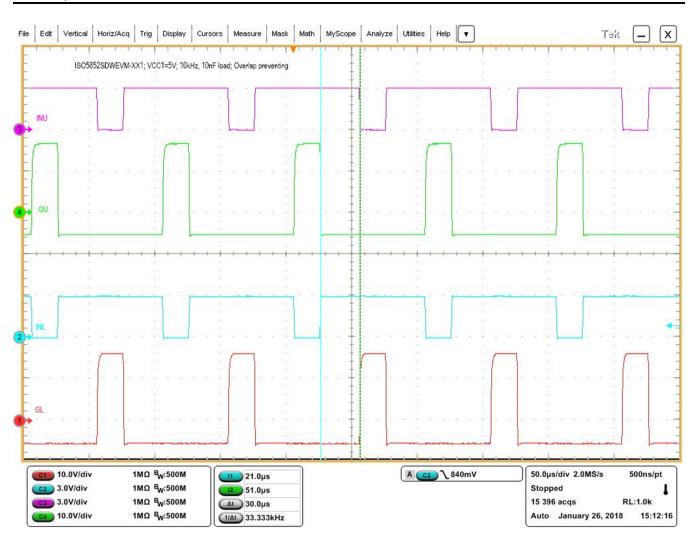


Figure 6. Major Input and Output Waveforms Using Output Overlapping Prevention Feature

- INU (pink) is high side input: 3.0V/div
  OU (green) is high side output: 10V/div
  INL (blue) is low side input: 3.0V/div
- OL (red) is low side output: 10V/div
- Time scale is 50µs/div



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## 2.2.3 Thermistor Amplifier Test

Test setup for thermistor amplifier test is shown in Figure 7.

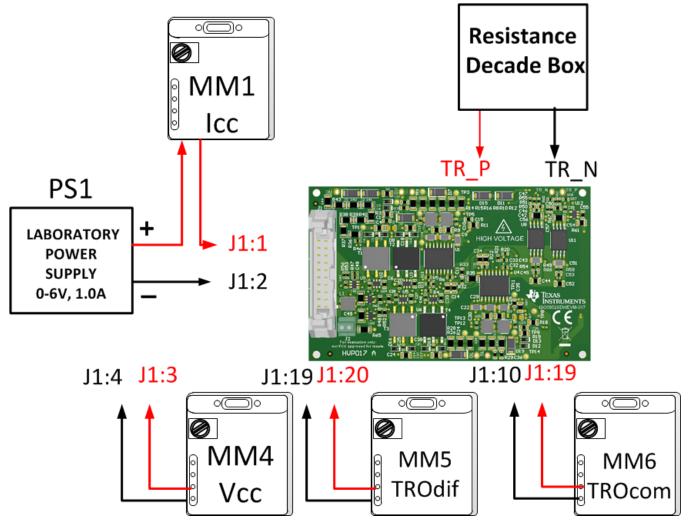


Figure 7. Thermistor Amplifier Test Setup

- 1. Enable power supply PS1
- 2. Gradually increase the voltage at PS1 into 4.95 V to 5.05 V range and monitor current using MM1 that should not exceed 150 mA
- Set resistances using Resistance Decade Box in accordance to Table 5 and monitor voltages at MM5 and MM6
- 4. Gradually reduce the voltage of power supply PS1 down to 0 V and disable it

Table 5.	Themistor	Amplifier	Output	Signals

RESISTANCE	5.0 kΩ	2.0 kΩ	800 Ω	280 Ω
MM5 (differential output)	1.85 V - 1.91 V	0.85 V - 0.91 V	0.36 V - 0.39 V	0.125 V - 0.145 V
MM6 (common output)	0.4 V - 0.6 V	0.8 V - 1.2 V	1.0 V - 1.4 V	1.2 V - 1.5 V



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#### 2.2.4 7 Sense Amplifier Test

Test setup for input bus voltage sense amplifier test is shown in Figure 8.

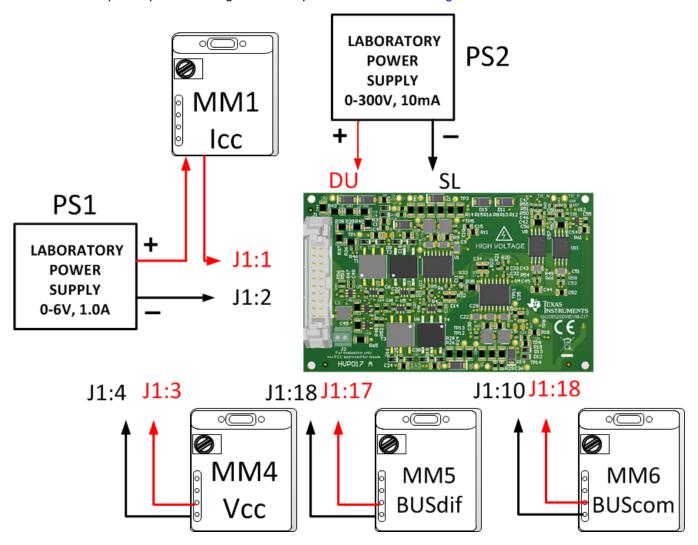


Figure 8. Input Bus Voltage Sense Amplifier Test Setup

- 1. Enable power supply PS1
- 2. Gradually increase the voltage at PS1 into 4.95 V to 5.05 V range and monitor current using MM1 that should not exceed 145 mA
- Enable power supply PS2
- 4. Gradually increase the voltage of power supply PS2 from 0 V up to 300 V and monitor voltages in accordance to Table 6
- 5. Gradually decrease the voltage of power supply PS2 down to 0 and disable it
- 6. Gradually reduce the voltage of power supply PS1 down to 0 V and disable it

**Table 6. Input Bus Voltage Sense Amplifier Outputs** 

PS2	0 V	49 V - 51 V	99 V - 101 V	149 V - 151 V	299 V - 301 V
MM5 (differential output)	0.28 V - 0.32 V	0.34 V - 0.38 V	0.39 V - 0.43 V	0.42 V - 0.48 V	0.58 V - 0.64 V
MM6 (common output)	1.15 V - 1.45 V	1.1 V - 1.4 V	1.05 V - 1.35 V	1.0 V - 1.3 V	0.95 V - 1.25 V



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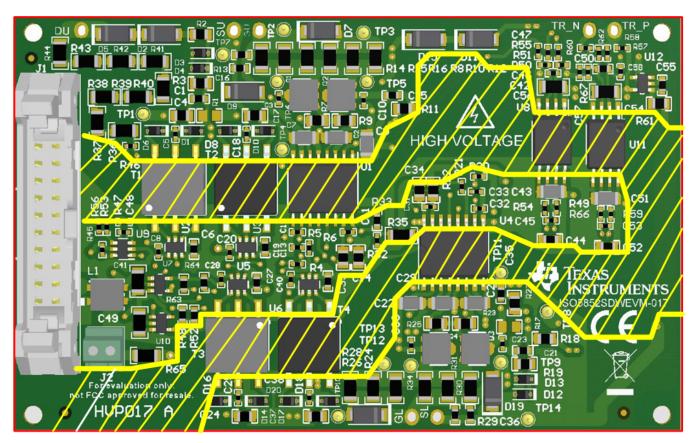


Figure 9. Safety Isolated Regions between High and Low Voltage Board Areas



Board Layout www.ti.com

# 3 Board Layout

General top and bottom view, component placement and all four layers are shown in Figure 10 through Figure 16 respectively.

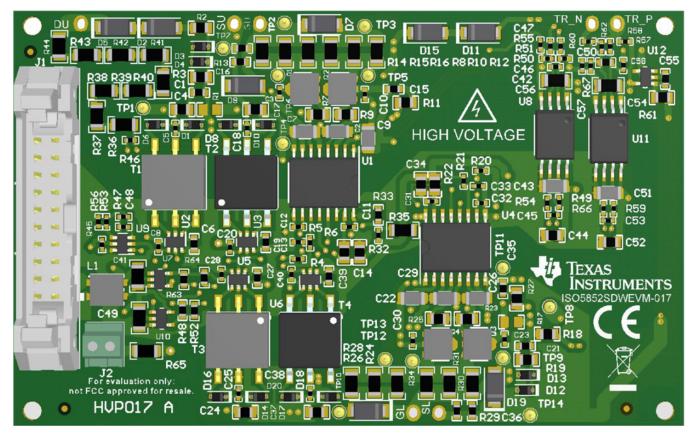


Figure 10. Top View of the Board



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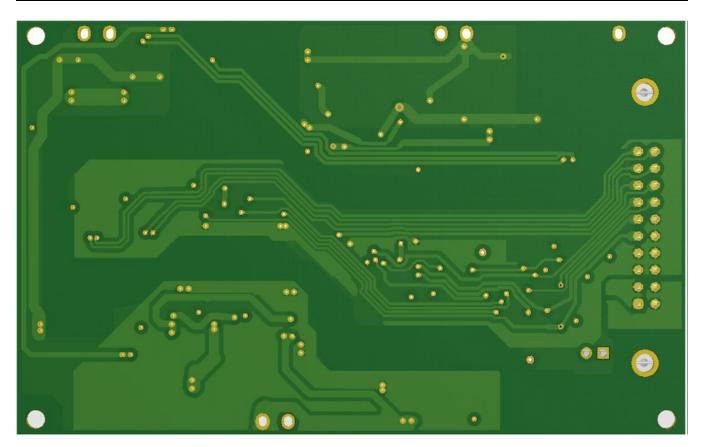


Figure 11. Bottom View Of The Board



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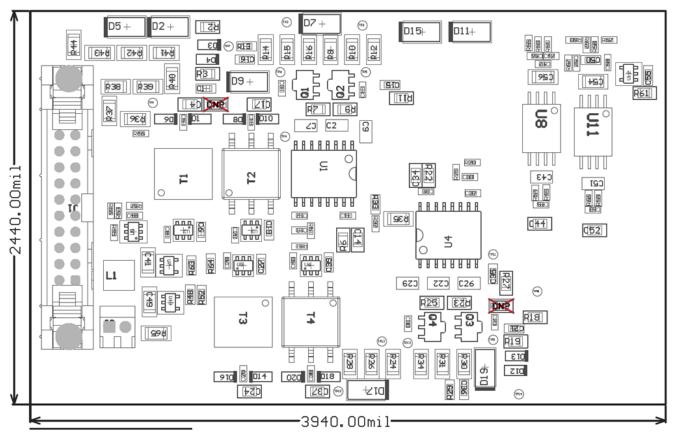


Figure 12. Component Placement



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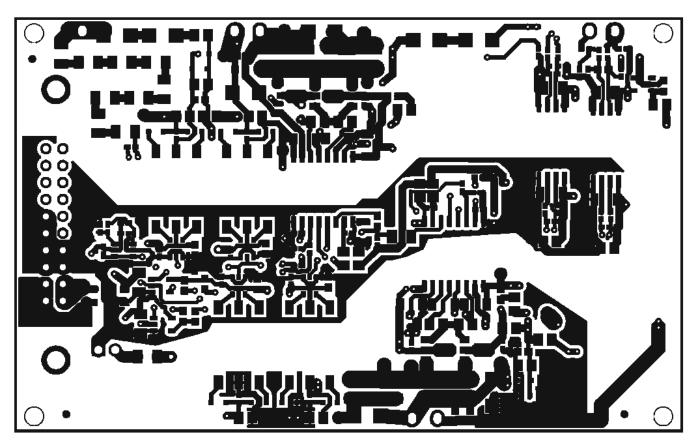


Figure 13. Top Layer



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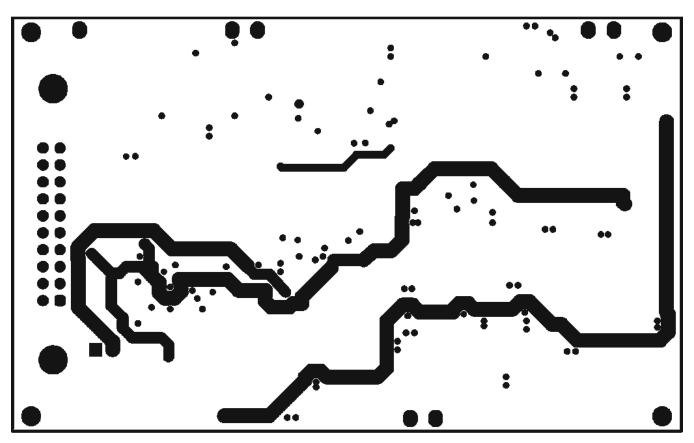


Figure 14. Signal Layer 1



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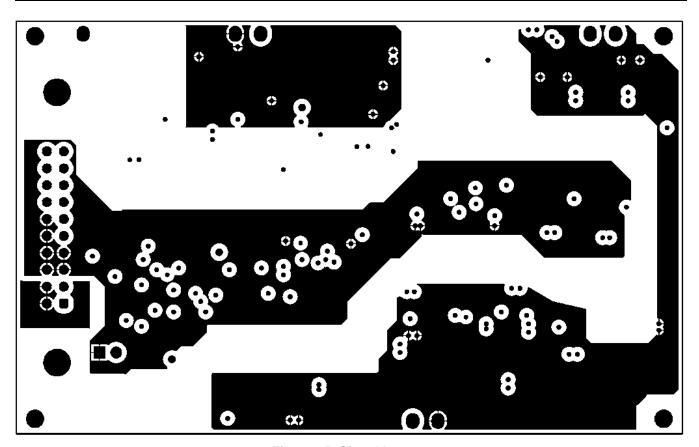


Figure 15. Signal Layer 2



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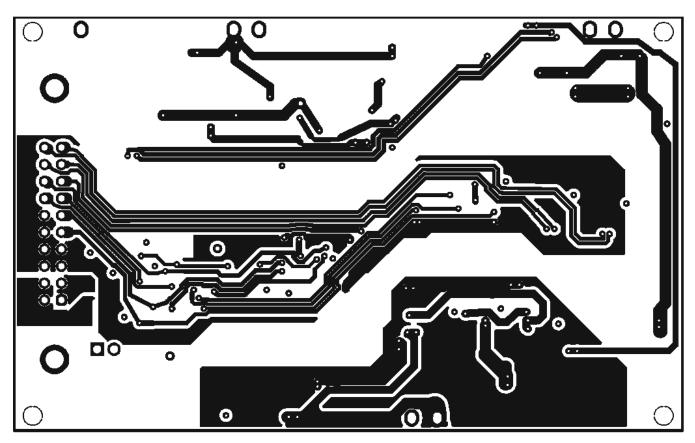


Figure 16. Bottom Layer



## 4 Schematic and Bill of Materials

#### 4.1 Schematic

The schematic of ISO5852SDWEVM-017 board is shown in Figure 17. Functional blocks of the schematic are shown in Figure 18 and below are listed the functions that related blocks perform.

- B1 high side +17.5V/-5V bias supply
- B2 low side +17.5V/-5V bias supply
- B3 connectors, UVLO/OVLO protection, fault and reset logic, overlapping option setting
- B4 high side driver with booster and desaturation protection
- B5 low side driver with booster and desaturation protection
- B6 input bus voltage sensing isolated amplifier
- B7 thermistor based temperature sense isolated amplifier

The ISO5852SDWEVM-017 EVM allows following adjustments depending on applications.

- By default the board set into output overlapping protection mode. Removing resistor shunts R48 and R52 allows output overlapping
- When attaching EVM to power module, it is recommended to remove output load capacitors C16 and C36
- To set turn ON and OFF output driver voltages beoynd the default, UVLO/OVLO protection can be disabled by removing resistor R53
- By removing resistive shunt R65 and using separate input supplies applied to connectors J1 and J2, turn ON and turn OFF drive voltages can be independently adjusted. The EVM maintains functionality if the VCC input supply voltages are within range from 3V to 5.5V. This allows set drive voltages approximately from +12 V to +21 V for turn ON drive voltage and from -3.5 V to -7 V for turn OFF drive voltage
- Change of C15 and C35 values allows soft shutdown adjustment during short circuit protection respectively for high side and low side drivers
- By default resistors R1 and R17 are not included. Adding these resistors provide additional current source for desaturation protection circuit



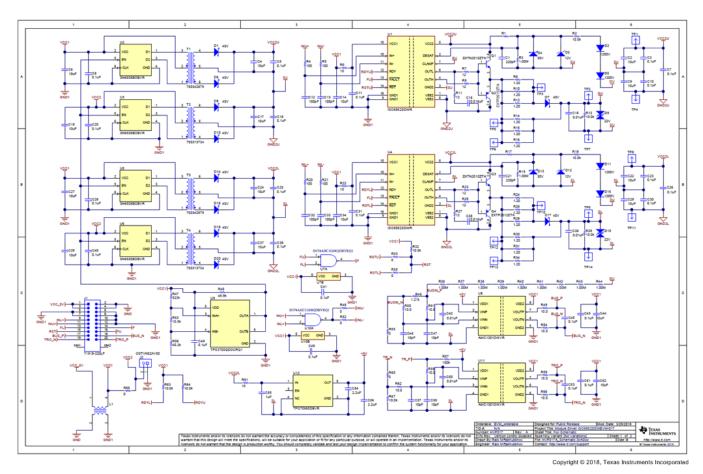


Figure 17. Electrical Schematic of ISO5852SDWEVM-017



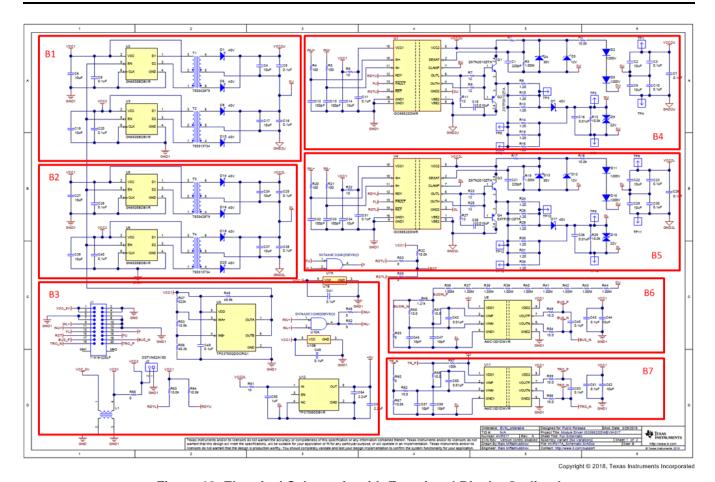


Figure 18. Electrical Schematic with Functional Blocks Outlined



Additional waveforms are shown below to illustrate described above adjustments and EVM drive current capabilities. Operation waveforms with overlapping enabled is shown in Figure 19.

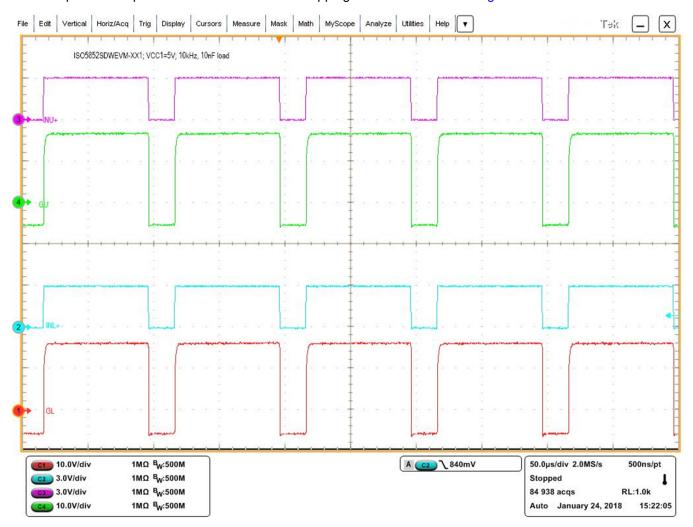


Figure 19. Waveforms with Overlapping Enabled

- INU (pink) is high side input: 3.0V/div
  OU (green) is high side output: 10V/div
  INL (blue) is low side input: 3.0V/div
  OL (red) is low side output: 10V/div
- Time scale is 50µs/div



Current capability during turn ON is illustrated in Figure 20 by rise time while charging 10 nF load capacitors

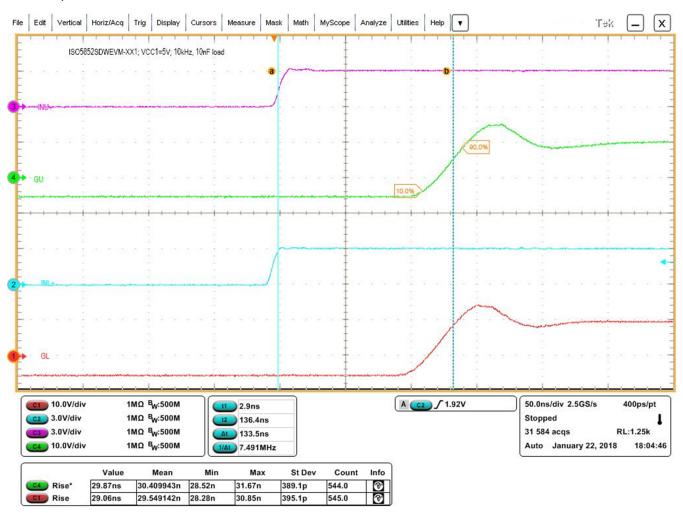


Figure 20. Rise Time and Propagation Delay Waveforms with 10 nF Load

- INU (pink) is high side input: 3.0V/div
  OU (green) is high side output: 10V/div
  INL (blue) is low side input: 3.0V/div
  OL (red) is low side output: 10V/div
- Time scale is 50ns/divRise time is about 30 ns
- Propagation delay is 133.5 ns



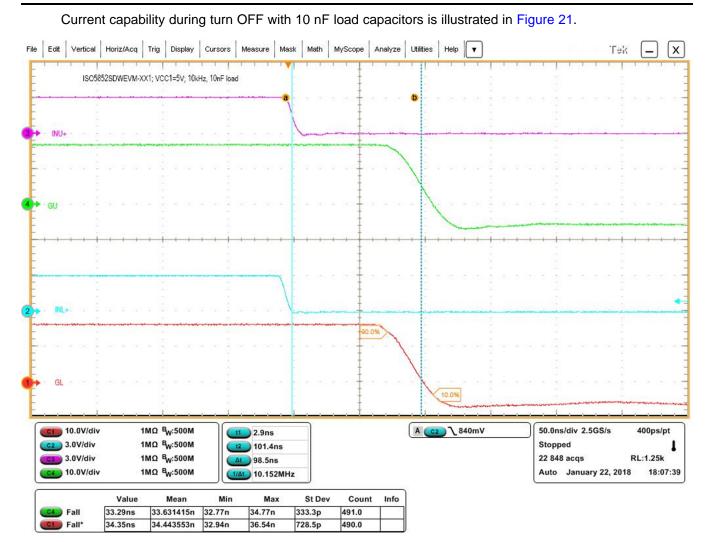


Figure 21. Fall Time and Propagation Delay Waveforms with 10 nF Load

- INU (pink) is high side input: 3.0V/div
  OU (green) is high side output: 10V/div
  INL (blue) is low side input: 3.0V/div
  OL (red) is low side output: 10V/div
- Time scale is 50ns/divFall time is about 34 ns
- Propagation delay is 98.5 ns



#### 4.2 Bill of Materials

# Table 7. Bill of Materials

C1. C21	DESIGNATOR	QTY	VALUE	PART NUMBER	MANUFACTURER	DESCRIPTION	PACKAGE REFERENCE
10.   10.	C1, C21	2	220pF	GRM188R71H221KA01D	MuRata		0603
C16. C22. C25. C36. 12	C2, C9, C22, C29	4	10uF	C3216X7R1V106M160AC	TDK		1206_190
1.	C18, C23, C25, C30,	12	0.1uF	C1005X7R1H104K050BB	TDK		0402
CFC, CFC, CFC, CFC, CFC, CFC, CFC, CFC	C4, C24	2	10uF	GRM21BR6YA106KE43L	MuRata		0805
C7. C26, C43, C51	C6, C19, C27, C39	4	10uF	C1608X5R1E106M080AC	TDK		0603
C48	C7, C26, C43, C51	4	0.1uF	CGA5L2X7R2A104K160AA	TDK	V, +/- 10%, X7R, AEC-	1206
C14, C17, C34, C37, C37, C36		5	0.1uF	GRM155R61A104KA01D	MuRata		0402
C44, C52	C12, C13, C32, C33	4	100pF	CC0402JRNPO9BN101	Yageo America		0402
C15, C35		6	10uF	C2012X5R1E106K125AB	TDK		0805
C16, C36	C15, C35	2	0.015uF	CGA3E2X7R2A153K080AA	TDK	100 V, +/- 10%, X7R, AEC-	0603
C42	C16, C36	2	0.01uF	GCM188R71H103KA37D	MuRata	V, +/- 10%, X7R, AEC-	0603
C46, C47, C57, C58	C41, C49	2	0.1uF	12061C104JAT2A	AVX		1206
C46, C47, C57, C58         4         10pF         04025U100CAT2A         AVX         V,-V-25%, C0G/NPO, ACC-Q200 Grade 1, 04022         0402           C50         1         0.01uF         C0603H103J3GACTU         Kemet         CAP, CERM, 0.01 uF, 25         0603           C54, C56         2         2.2uF         C1206C225K4RACTU         Kemet         CAP, CERM, 2 uF, 16 V, 4-10%, XTR, 1206         1206           C55         1         1uF         UMK107AB7105KA-T         Talyo Yuden         CAP, CERM, 1 uF, 50 V, 4-10%, XTR, 1003         6603           D1, D6, D8, D10, D10, D10, D18, D20         8         40V         B0540WS-7         Diodes Inc.         Diodes, Schottky, 40 V, 0.5 A, SOD-323         SOD-323           D2, D5, D11, D15         4         1200V         STTH112A         STMicroelectronics         Diode, Schottky, 40 V, 0.5 A, SOD-323         SOD-323           D2, D5, D11, D15         4         1200V         STTH112A         STMicroelectronics         Diode, Schottky, 40 V, 0.5 A, SOD-323         SOD-323           D2, D5, D11, D15         4         1200V         BAT54WS-7-F         Diodes Inc.         Diode, Schottky, 40 V, 0.2 A, SOD-323         SOD-323           D4, D13         2         30V         BAT54WS-7-F         Diodes Inc.         Diode, Schottky, 40 V, 0.2 A, SOD-323         SOD-323 <td>C42</td> <td>1</td> <td>0.01uF</td> <td>C0402C103J5RACTU</td> <td>Kemet</td> <td></td> <td>0402</td>	C42	1	0.01uF	C0402C103J5RACTU	Kemet		0402
C54, C56   2   2.2 uF   C1206C225K4RACTU	C46, C47, C57, C58	4	10pF	04025U100CAT2A	AVX	V,+/- 2.5%, C0G/NP0,	0402
C54, C56   2   Z2IF   C1206/225N4RACTU   Nemet	C50	1	0.01uF	C0603H103J3GACTU	Kemet		0603
1	C54, C56	2	2.2uF	C1206C225K4RACTU	Kemet		1206
Dide   Dide   Diode   Diode	C55	1	1uF	UMK107AB7105KA-T	Taiyo Yuden		0603
DZ, DS, DT, DTS		8	40V	B0540WS-7	Diodes Inc.		SOD-323
D3, D12         2         12V         MMS25242BS-7-F         Diodes Inc.         mW, SOD-323         SOD-323           D4, D13         2         30V         BAT54WS-7-F         Diodes Inc.         Diode, Schottky, 30 V, 0.2 A, SOD-323         SOD-323           D7, D17         2         40V         B240A-13-F         Diodes Inc.         Diode, Schottky, 40 V, 2 A, SMA         SMA           D9, D19         2         22V         SMAJ22CA         Littelfuse         Diode, TVS, Bi, 22 V, SMA         SMA           FID1, FID2, FID3         3         N/A         N/A         Fiducial mark. There is nothing to buy or mount.         N/A           J1         71918-220LF         FCI         Header(shrouded), 2.54mm, 10x2, Gold with Tin tail, TH         Diode, Schottky, 40 V, 2 A, SMA           J2         1         OSTVN02A150         On-Shore Technology         Terminal Block, 2.54mm, 2.70el, Brass, TH           J2         1         OSTVN02A150         TDK         Coupled inductor, 2.8 A, 0.055 ohm, SMD         A.7x4.5mm           L1         1         ACM4520-421-2P-T000         TDK         Coupled inductor, 2.8 A, 0.055 ohm, SMD         A.7x4.5mm           Q1, Q3         2         60 V         ZXTN2010ZTA         Diodes Inc.         Transistor, NPN, 60 V, 4.3 A, AEC-Q101, SOT-89         SOT-89	D2, D5, D11, D15	4	1200V	STTH112A	STMicroelectronics		SMA
D4, D13	D3, D12	2	12V	MMSZ5242BS-7-F	Diodes Inc.		SOD-323
December 2   100   December 3   December 3	D4, D13	2	30V	BAT54WS-7-F	Diodes Inc.		SOD-323
FID1, FID2, FID3         3         N/A         N/A         Fiducial mark. There is nothing to buy or mount.         N/A           J1         1         71918-220LF         FCI         Header(shrouded), 2.54mm, 10x2, Gold with Tin tail, TH         Header(shrouded), 2.54mm, 10x2, FM         Header(shrouded), 2.54mm, 10x2, TH         Header(shrouded), 2.54mm, 10x2, FM         The minal Block, 2.54mm,	D7, D17	2	40V	B240A-13-F	Diodes Inc.		SMA
FID1, FID2, FID3   3	D9, D19	2	22V	SMAJ22CA			SMA
J1       71918-220LF       2.54mm, 10x2, Gold with Tin tail, TH       d), 2.54mm, 10x2, TH         J2       1       OSTVN02A150       Terminal Block, 2.54mm, 2x1, Brass, TH       Terminal Block, 2.54mm, 2-pole, Brass, TH         L1       1       ACM4520-421-2P-T000       TDK       Coupled inductor, 2.8 A, 0.055 ohm, SMD       4.7x4.5mm         Q1, Q3       2       60 V       ZXTN2010ZTA       Diodes Inc.       Transistor, NPN, 60 V, 5 A, AEC-Q101, SOT-89       SOT-89         Q2, Q4       2       60 V       ZXTP2012ZTA       Diodes Inc.       Transistor, PNP, 60 V, 4.3 A, AEC-Q101, SOT-89       SOT-89         P1 P17       2       1 00k       EPL P0651001V       Panasonic       RES, 1.00 k, 1%, 0.25 W, 0.905	FID1, FID2, FID3	3		N/A	N/A		N/A
J2       1       OSTVN02A150       2x1, Brass, TH       2,54mm, 2-pole, Brass, TH         L1       1       ACM4520-421-2P-T000       TDK       Coupled inductor, 2.8 A, 0.055 ohm, SMD       4,7x4.5mm         Q1, Q3       2       60 V       ZXTN2010ZTA       Diodes Inc.       Transistor, NPN, 60 V, 5 A, AEC-Q101, SOT-89       SOT-89         Q2, Q4       2       60 V       ZXTP2012ZTA       Diodes Inc.       Transistor, PNP, 60 V, 4.3 A, AEC-Q101, SOT-89       SOT-89         P1 P17       2       1 00k       EB L P0651001V       Panasonic       RES, 1.00 k, 1%, 0.25 W, 0.905	J1	1		71918-220LF	FCI	2.54mm, 10x2, Gold with	d), 2.54mm,
LT         1         ACM4520-421-2P-1000         0.055 ohm, SMD         4.7X4.smm           Q1, Q3         2         60 V         ZXTN2010ZTA         Diodes Inc.         Transistor, NPN, 60 V, 5 A, AEC-Q101, SOT-89         SOT-89           Q2, Q4         2         60 V         ZXTP2012ZTA         Diodes Inc.         Transistor, PNP, 60 V, 4.3 A, AEC-Q101, SOT-89         SOT-89           P1 P17         2         1 00k         ED L P0651001V         Panasonic         RES, 1.00 k, 1%, 0.25 W, 0905	J2	1		OSTVN02A150	On-Shore Technology		2.54mm, 2-pole,
Q2, Q4	L1	1		ACM4520-421-2P-T000	TDK		4.7x4.5mm
Q2, Q4	Q1, Q3	2	60 V	ZXTN2010ZTA	Diodes Inc.		SOT-89
	Q2, Q4	2	60 V	ZXTP2012ZTA	Diodes Inc.		SOT-89
	R1, R17	2	1.00k	ERJ-P06F1001V	Panasonic		0805



# Table 7. Bill of Materials (continued)

DESIGNATOR	QTY	VALUE	PART NUMBER	MANUFACTURER	DESCRIPTION	PACKAGE REFERENCE
R2, R18	2	10.0k	CRCW080510K0FKEA	Vishay-Dale	RES, 10.0 k, 1%, 0.125 W, 0805	0805
R3, R19	2	1.00Me g	CRCW08051M00FKEA	Vishay-Dale	RES, 1.00 M, 1%, 0.125 W, 0805	0805
R4, R5, R20, R21	4	100	CRCW0402100RFKED	Vishay-Dale	RES, 100, 1%, 0.063 W, 0402	0402
R6, R22, R61	3	10	CRCW080510R0JNEA	Vishay-Dale	RES, 10, 5%, 0.125 W, 0805	0805
R7, R9, R11, R23, R25, R27	6	12	CRCW080512R0JNEA	Vishay-Dale	RES, 12, 5%, 0.125 W, 0805	0805
R8, R10, R12, R14, R15, R16, R24, R26, R28, R30, R31, R34	12	1.20	CRCW12061R20FKEA	Vishay-Dale	RES, 1.20, 1%, 0.25 W, AEC-Q200 Grade 0, 1206	1206
R13, R29, R63, R64	4	10.0k	RC0603FR-0710KL	Yageo America	RES, 10.0 k, 1%, 0.1 W, 0603	0603
R32, R67	2	10.0k	RMCF0402FT10K0	Stackpole Electronics Inc	RES, 10.0 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R33, R48, R52	3	0	ERJ-3GEY0R00V	Panasonic	RES, 0, 5%, 0.1 W, 0603	0603
R35, R65	2	0	MCR18EZHJ000	Rohm	RES, 0, 5%, 0.25 W, 1206	1206
R36, R37, R38, R39, R40, R41, R42, R43, R44	9	1.00Me g	CRCW12061M00FKEA	Vishay-Dale	RES, 1.00 M, 1%, 0.25 W, 1206	1206
R45	1	49.9k	CRCW040249K9FKED	Vishay-Dale	RES, 49.9 k, 1%, 0.063 W, 0402	0402
R46	1	1.21k	CRCW04021K21FKED	Vishay-Dale	RES, 1.21 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R47	1	523k	CRCW0402523KFKED	Vishay-Dale	RES, 523 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R49, R50, R51, R54, R58, R59, R62, R66	8	10.0	CRCW040210R0FKED	Vishay-Dale	RES, 10.0, 1%, 0.063 W, 0402	0402
R53	1	10.5k	CRCW040210K5FKED	Vishay-Dale	RES, 10.5 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R55, R60	2	0	CRCW04020000Z0ED	Vishay-Dale	RES, 0, 5%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R56	1	40.2k	CRCW040240K2FKED	Vishay-Dale	RES, 40.2 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
R57	1	100k	RMCF0402FT100K	Stackpole Electronics Inc	RES, 100 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402
T1, T3	2	50uH	750342879	Wurth Elektronik	Transformer, 50 uH, SMT	9.14x8mm
T2, T4	2	340uH	750313734	Wurth Elektronik	Transformer, 340 uH, TH	8x9.14mm
TP1, TP2, TP3, TP4, TP5, TP6, TP7, TP8, TP9, TP10, TP11, TP12, TP13, TP14	14		0508-0-00-15-00-00-03-0	Mill-Max	PCB Pin, 20mil Dia, Gold, TH	PCB Pin, 20mil Dia, TH
U1, U4	2		ISO5852SDWR	Texas Instruments	5.7 kVrms Split O/P, Reinforced Isolated IGBT Gate Driver, DW0016B (SOIC-16)	DW0016B
U2, U3, U5, U6	4		SN6505BDBVR	Texas Instruments	Low-Noise 1 A, 420 kHz Transformer Driver, DBV0006A (SOT-23-6)	DBV0006A
U7, U10	2		SN74AHC1G08QDBVRQ1	Texas Instruments	Automotive Catalog Single 2-Input Positive-AND Gate, DBV0005A, LARGE T&R	DBV0005A
U8, U11	2		AMC1301DWVR	Texas Instruments	Precision +/-250-mV Input, 3-us Delay, Reinforced Isolated Amplifier, DWV0008A (SOIC-8)	DWV0008A
U9	1		TPS3700QDDCRQ1	Texas Instruments	Automotive, High-Voltage (18V) Window Comparator with Over- and Undervoltage Detection, DDC0006A (SOT-23-T-6)	DDC0006A
U12	1		TPS70950DBVR	Texas Instruments	150-mA, 30-V, Ultra-Low IQ, Wide Input Low- Dropout Regulator with Reverse Current Protection, DBV0005A (SOT-23-5)	DBV0005A

#### STANDARD TERMS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
  - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
  - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after the defect has been detected.
  - 2.3 Tl's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. Tl's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by Tl and that are determined by Tl not to conform to such warranty. If Tl elects to repair or replace such EVM, Tl shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.
- 3 Regulatory Notices:
  - 3.1 United States
    - 3.1.1 Notice applicable to EVMs not FCC-Approved:

**FCC NOTICE:** This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC - FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### **CAUTION**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

#### 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

#### **Concerning EVMs Including Radio Transmitters:**

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

## Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

#### 3.3 Japan

- 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
  http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page
- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
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- なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。 上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。 日本テキサス・イ

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3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page

#### 3.4 European Union

3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

- 4 EVM Use Restrictions and Warnings:
  - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
  - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
  - 4.3 Safety-Related Warnings and Restrictions:
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    - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
  - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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